

FAST SWITCHING THYRISTOR

APPLICATIONS

- High Power Inverters And Choppers.
- UPS.
- Railway Traction.
- Induction Heating.
- AC Motor Drives.
- Cycloconverters.

FEATURES

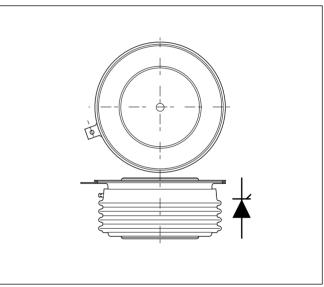
- Double Side Cooling.
- High Surge Capability.
- High Voltage.

VOLTAGE RATINGS

Type Number	Repetitive Peak Voltages V _{DRM} V _{RRM}	Conditions
TF708 20B	2000	$V_{RSM} = V_{RRM} + 100V$
TF708 18B	1800	
TF708 16B	1600	$I_{\text{DRM}} = I_{\text{RRM}} = 60 \text{mA}$
		at $V_{_{ m RRM}}$ or $V_{_{ m DRM}}$ & T $_{_{ m vj}}$

Lower voltage grades available.

KEY PARAMETERS					
V_{dRM}	2000V				
T(RMS)	750A				
I _{TSM}	8000A				
dV/dt	300V/ μs				
dl/dt	500A/ μs				
t _q	40 μs				



Outline type code: MU171. See package outlines for further information.

CURRENT RATINGS

Symbol	Parameter Conditions		Max.	Units
I _{T(AV)}	Mean on-state current	Half sinewave, 50Hz, $T_{case} = 80^{\circ}C$	480	А
I _{T(RMS)}	RMS value	Half sinewave, 50Hz, T _{case} = 80°C	750	А

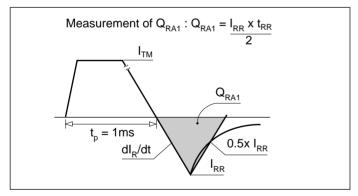
SURGE RATINGS

Symbol	Parameter Conditions		Max.	Units
I _{TSM}	Surge (non-repetitive) on-state current	10ms half sine; $V_{R} = 0\% V_{RRM}$, $T_{j} = 125^{\circ}C$	8.0	kA
l ² t	l ² t for fusing	10ms half sine; $V_R = 0\% V_{RRM}$, $T_j = 125^{\circ}C$	320 x 10 ³	A²s

THERMAL AND MECHANICAL DATA

Symbol	Parameter	Conditions		Min.	Max.	Units
R _{th(j-c)} Thermal resistance - junct	Thermal resistance - junction to case	Double side cooled	dc	-	0.04	°C/W
			Anode dc	-	0.072	°C/W
		Single side cooled	Cathode dc	-	0.096	°C/W
	Thermal resistance - case to heatsink	Clamping force 15.0kN with mounting compound	Double side	-	0.01	°C/W
R _{th(c-h)} The			Single side	-	0.02	°C/W
T _{vj} Vii	Virtual junction temperature	On-state (conducting)		-	125	°C
		Reverse (blocking)		-	125	°C
T _{stg}	Storage temperature range			-40	150	°C
-	Clamping force			14.25	15.75	kN

MEASUREMENT OF RECOVERED CHARGE - Q_{RA1}



DYNAMIC CHARACTERISTICS

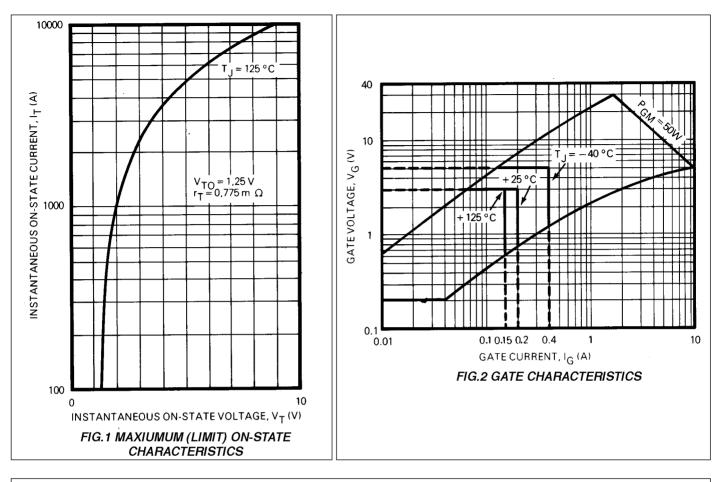
Symbol	Parameter	Conditions		Min.	Max.	Units
V _{TM}	Maximum on-state voltage	At 2000A peak, T _{case} = 25°C		-	2.8	V
I _{rrm} /I _{drm}	Peak reverse and off-state current	At $V_{\text{RRM}}/V_{\text{DRM}}$, $T_{\text{case}} = 125^{\circ}\text{C}$	At V_{RRM}/V_{DRM} , $T_{case} = 125^{\circ}C$		60	mA
dV/dt	Maximum linear rate of rise of off-state voltage	Linear to 60% $V_{DRM} T_j = 125^{\circ}C$, Gate open circuit		-	300	V/μs
dl/dt		Gate source 20V, 20Ω	Repetitive 50Hz	-	500	A/μs
ui/ut	Rate of rise of on-state current	$t_r \le 0.5 \mu s$, $T_j = 125^{\circ}C$	Non-repetitive	-	800	A/μs
V _{T(TO)}	Threshold voltage	At $T_{vj} = 125^{\circ}C$		-	1.25	V
r _T	On-state slope resistance	At T _{vj} = 125°C		-	0.77	mΩ
t _{gd}	Delay time	$T_{j} = 25^{\circ}C, I_{T} = 50A,$ $V_{D} = 300V, I_{G} = 1A,$		-	2*	μs
t _{(ON)TOT}	Total turn-on time	$V_{\rm D} = 300V$, $I_{\rm G} = 1A$, dl/dt = 50A/µs, dl _G /dt = 1A/µs		-	4*	μs
I _H	Holding current	$T_{j} = 25^{\circ}C, I_{TM} = 1A, V_{D} = 12V$		100*	-	mA
I _L	Latching current	$T_{j} = 25^{\circ}C, I_{g} = 0.5A, V_{D} = 12V$		300*	-	mA
t _q	Turn-off time	$T_j = 125^{\circ}C$, $I_T = 250A$, $V_R = 50V$ dV/dt = 20V/µs (Linear to 60% dI _R /dt = 50A/µs, Gate open circ	V _{DRM}), ^Y	-	40	μs

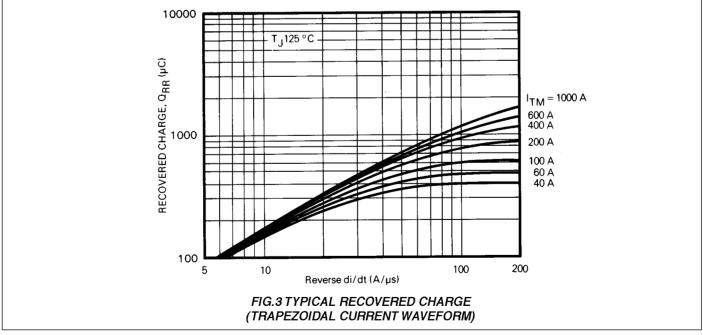
*Typical value.

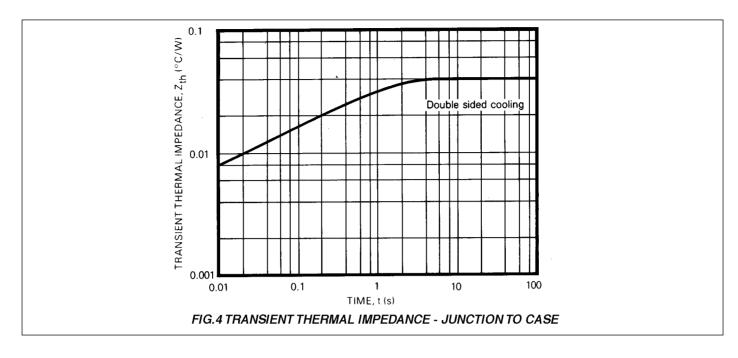
GATE TRIGGER CHARACTERISTICS AND RATINGS

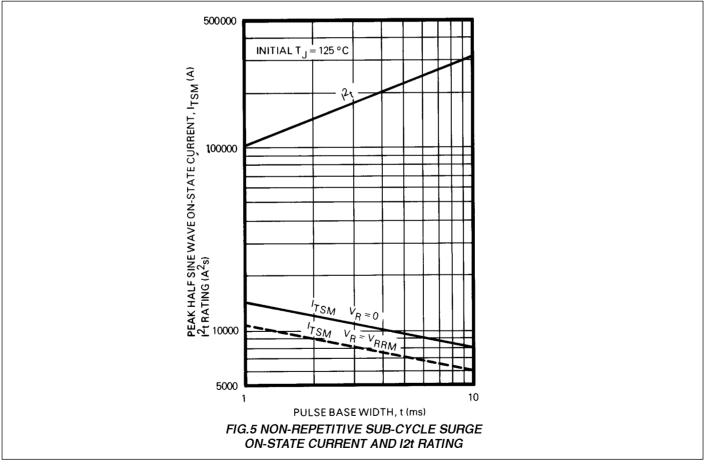
Symbol	Parameter	Conditions	Тур.	Max.	Units
V _{gt}	Gate trigger voltage	$V_{\text{DRM}} = 12V, T_{\text{case}} = 25^{\circ}\text{C}, R_{\text{L}} = 6\Omega$	-	3.0	V
I _{GT}	Gate trigger current	$V_{\text{DRM}} = 12V, \ T_{\text{case}} = 25^{\circ}C, \ R_{\text{L}} = 6\Omega$	-	200	mA
V _{GD}	Gate non-trigger voltage	At $V_{\text{DRM}} T_{\text{case}} = 125^{\circ}\text{C}$, $R_{\text{L}} = 1\text{k}\Omega$	-	0.2	V
V _{RGM}	Peak reverse gate voltage		-	5.0	V
I _{FGM}	Peak forward gate current	Anode positive with respect to cathode	-	10	A
P _{GM}	Peak gate power		-	50	W
P _{G(AV)}	Mean gate power		-	3	W

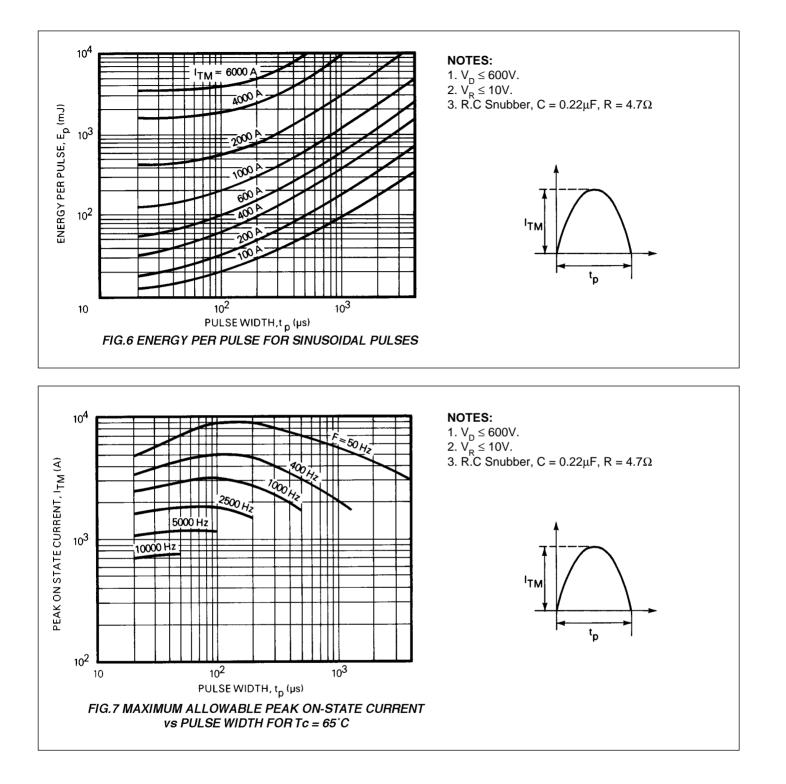
CURVES

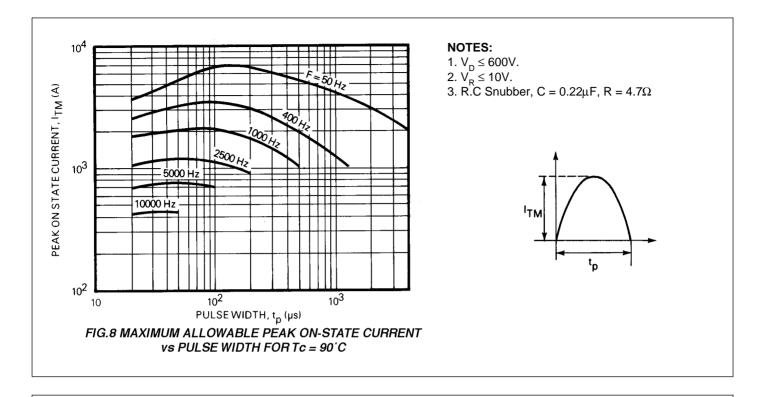


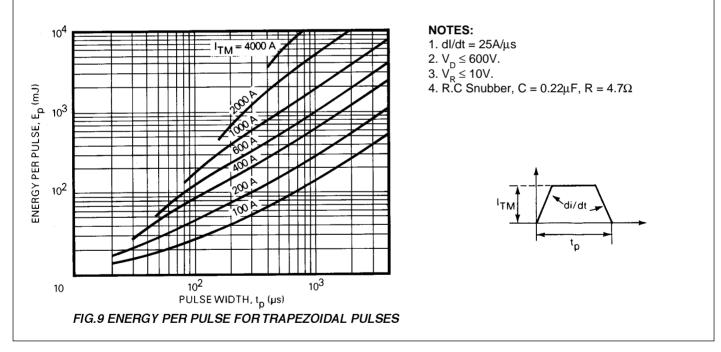


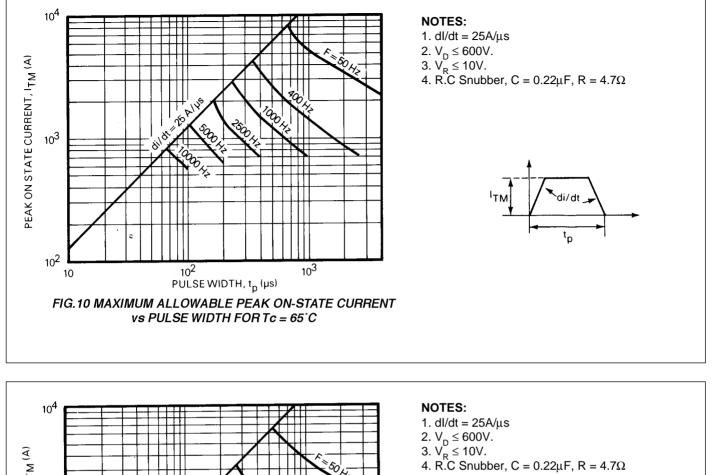


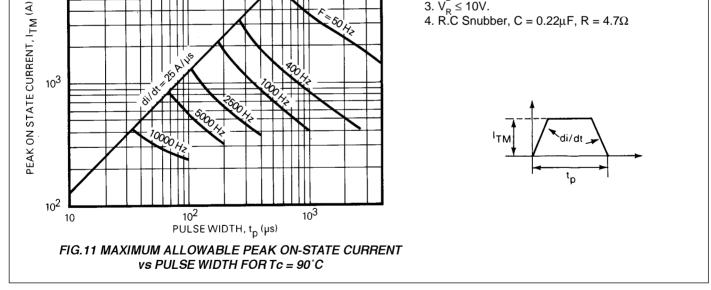












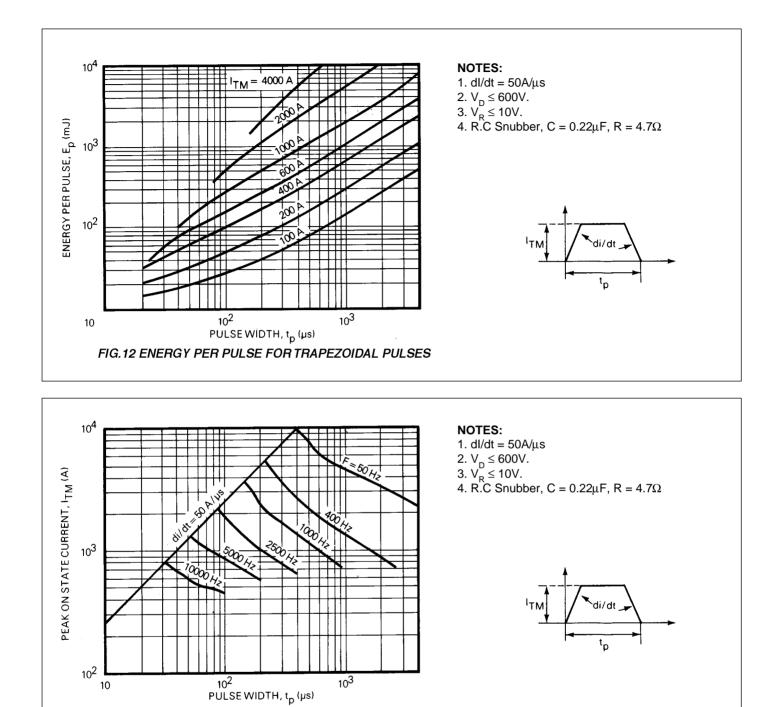
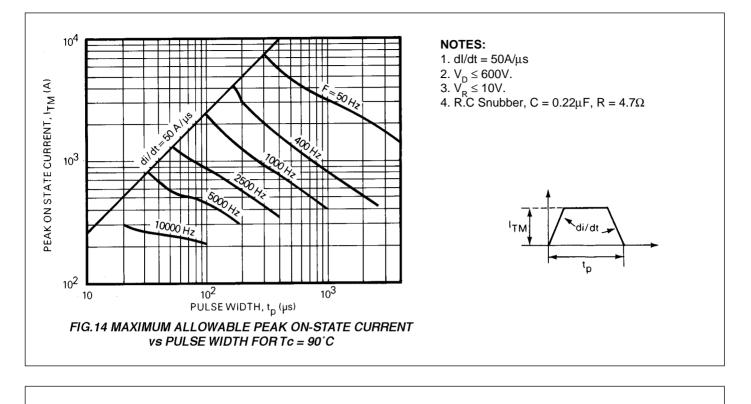
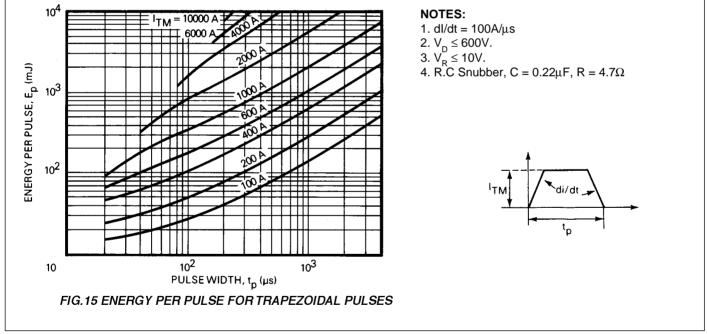
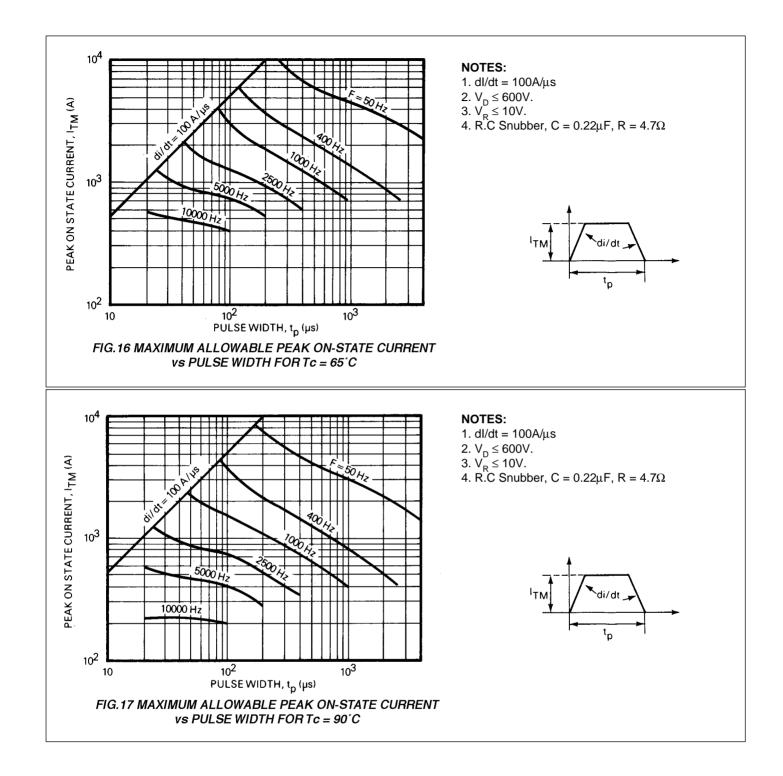


FIG.13 MAXIMUM ALLOWABLE PEAK ON-STATE CURRENT vs PULSE WIDTH FOR Tc = 65°C

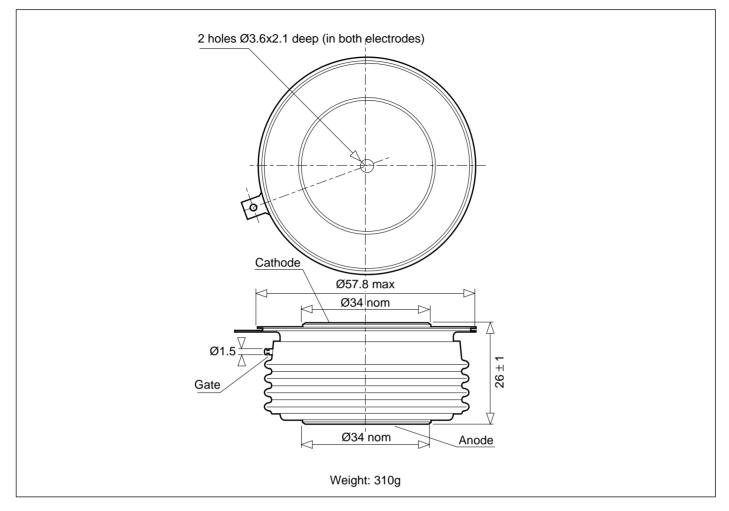






PACKAGE DETAILS - MU171

For further package information, please contact your local Customer Service Centre. All dimensions in mm, unless stated otherwise. DO NOT SCALE.



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